

*Paragon Semiconductor Lighting Technology*

*PSLT*

**ParagonLED**

## Specifications

Product Type : G2C000100-120V18WD30

Issued Date : 11/01/2016

# Contents

## 1. General Description

1-1 Naming Rule

1-2 Outline dimensions

## 2. Electro-optical characteristics

2-1 Absolute Maximum Rating

2-2 Electro-optical characteristics

2-3 Graphs

2-4 Layout

## 3. Junction Temperature measurement

## 4. Reliability Test

# 1.General Description

## (1)Naming rule

**G2C000100-120V18WD30**

Dimming : Available

Product Series type : C

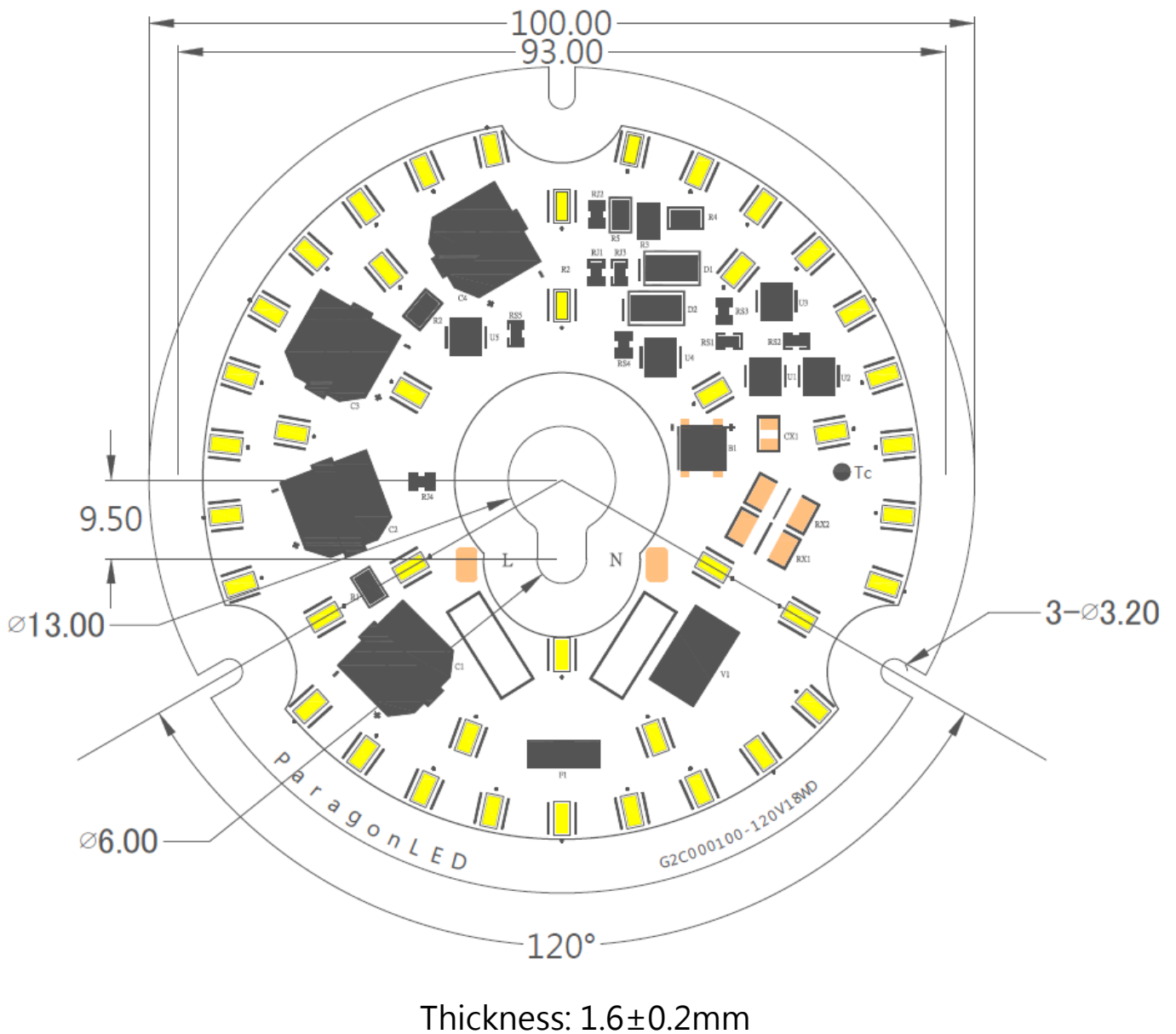
Outline Dimension : 100.0mm

Voltage : 120VAC

Power Dissipation : 18W

Color Temperature : 3000K

## (2)Outline Dimensions (Unit : mm / Tolerance: 0.2mm)



## 2. Electro-Optical Characteristics

### (1) Absolute Maximum Rating

Parameter	Symbol	Value	Unit
Power Dissipation	$P_D$	18	W
Forward Voltage	$V_F$	120	V
Operating Temperature	$T_{opr}$	-40 ~ +105	°C
Storage Temperature	$T_{stg}$	-40 ~ +105	°C
Power Factor	Pf	>0.95	
Dimming Type	Uniform Dimming		
Surge Protection	1.5KV		
Assembly process temperature	$T_{sol}$	<325°C , 5 secs	

### (2) Electro-Optical Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	$V_F$	-	-	120	-	V
Luminous Intensity	$\Phi_v$	$V_F=120V$	-	1450	-	Lm
Color rendering	Ra	$V_F=120V$	-	90	-	CRI

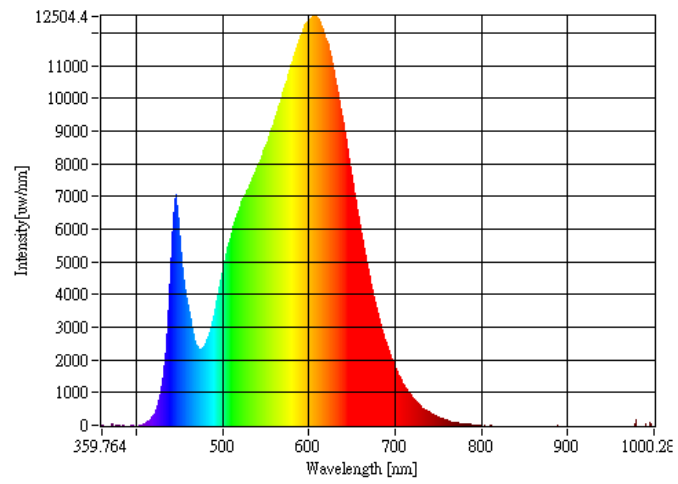
**Notice: Operating Voltage of product varies from 110V~140V · users must keep the temperature of solder joint point under 85 °C (with suitable heat sink), or may cause Serious luminous decay. We DO NOT guarantee of improper use.**

### (3) Percent Flicker

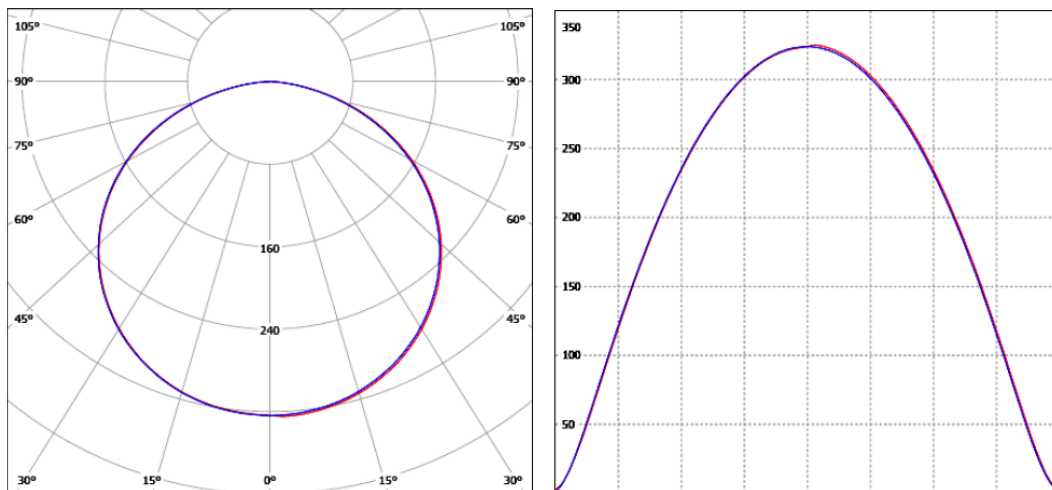
Voltage	10%	20%	30%	40%	50%	60%	70%	80%	90%	100%
Wattage	1.8W	3.6W	5.4W	7.2W	9W	10.8W	12.6W	14.4W	16.2W	18W
Flicker MAX(A)	0.120	0.344	0.544	0.700	0.860	1.020	1.140	1.300	1.420	1.480
Flicker MIN(B)	0.066	0.190	0.295	0.380	0.480	0.560	0.620	0.720	0.840	0.880
Flicker (%)	29.03%	28.84%	29.68%	29.63%	28.36%	29.11%	29.55%	28.71%	25.66%	25.42%

### (3) Graphs

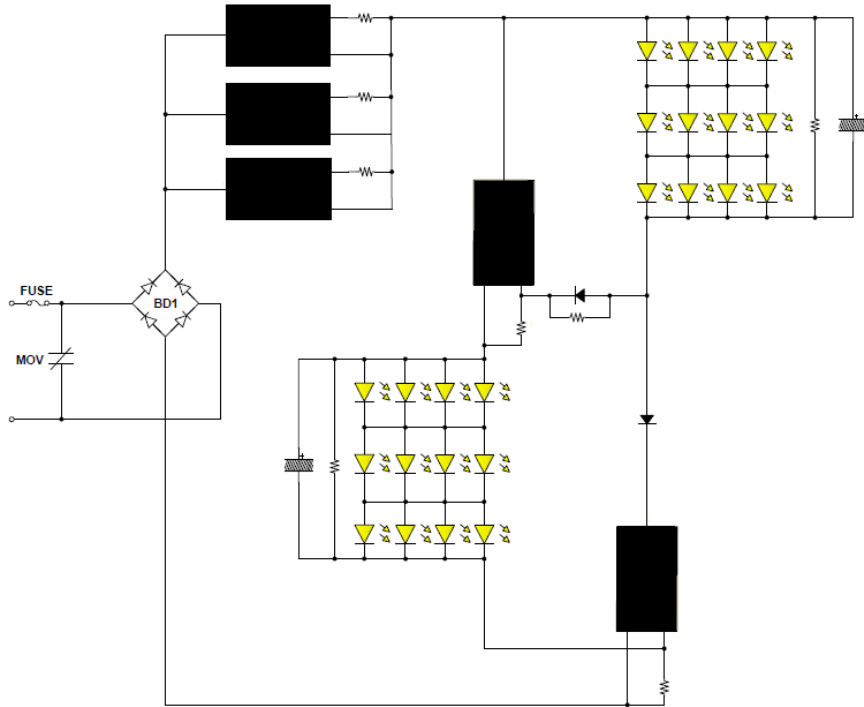
#### Spectrum



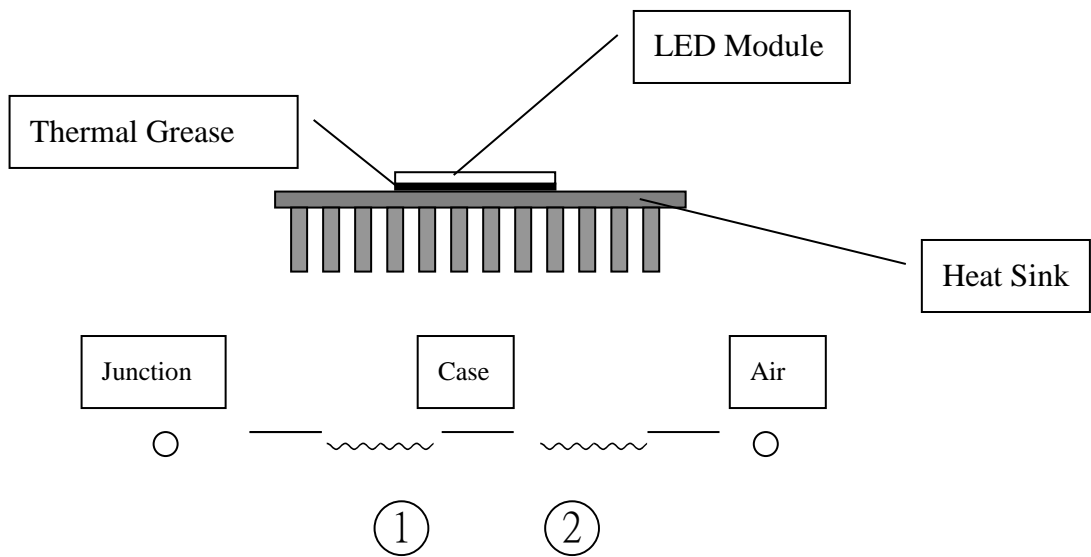
#### Candle Power Distribution & Cartesian Coordinate



## (4)Layout



## 3.Junction Temperature Measurement



- ① Thermal resistance of Junction to Case without heat sink :  $10^{\circ}\text{C}/\text{W}$  [ Reference Value ]
- ② Thermal resistance of Case to Ambient Air: Depending on what kind of heat sink users choose. In ideal thermal dissipation situation, the thermal resistance is about  $1\sim 2^{\circ}\text{C}/\text{W}$ .

## 4. Reliability Test

Test Item	Test Conditions	Number of failed
High Temperature Storage Test	Tstg= +80°C , x1,000 hrs	0/20
Low Temperature Storage Test	Tstg= -40°C , x1,000 hrs	0/20
Continous Light-on Test	Ta= 25°C , RH=65%, x1,000 hrs	0/20
Boiling Test	Ta= 100°C , RH=100%, x180mins	0/20
Thermal Cycle Test	-40°C x 30 mins, 80°C x 30 mins, 100 cycles	0/20

Measuring Item	Measuring Condition	Judging Criteria of Failure
Forward Voltage	$I_F = 120V$	$> 0 \times 1.1$
Total Luminous Flux	$I_F = 120V$	$< L \times 0.7$